

N-Channel 20-V (D-S) MOSFET

Key Features:

- Low $r_{DS(on)}$ trench technology
- Low thermal impedance
- Fast switching speed

Typical Applications:

- White LED boost converters
- Automotive Systems
- Industrial DC/DC Conversion Circuits

PRODUCT SUMMARY

V_{DS} (V)	$r_{DS(on)}$ (m Ω)	I_D (A)
20	18 @ $V_{GS} = 4.5V$	7.0
	21 @ $V_{GS} = 2.5V$	6.5

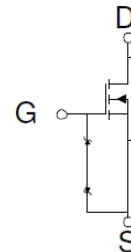
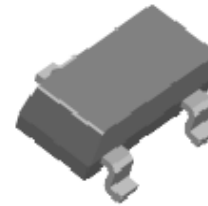
SOT-23



RoHS
COMPLIANT
HALOGEN
FREE



ESD Protected
2000V



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 8	
Continuous Drain Current ^a	I_D	7.0	A
		5.5	
Pulsed Drain Current ^b	I_{DM}	20	
Continuous Source Current (Diode Conduction) ^a	I_S	1.9	A
Power Dissipation ^a	P_D	1.3	W
		0.8	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Maximum	Units
Maximum Junction-to-Ambient ^a	$R_{\theta JA}$	100	$^\circ\text{C/W}$
		166	

Notes

- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

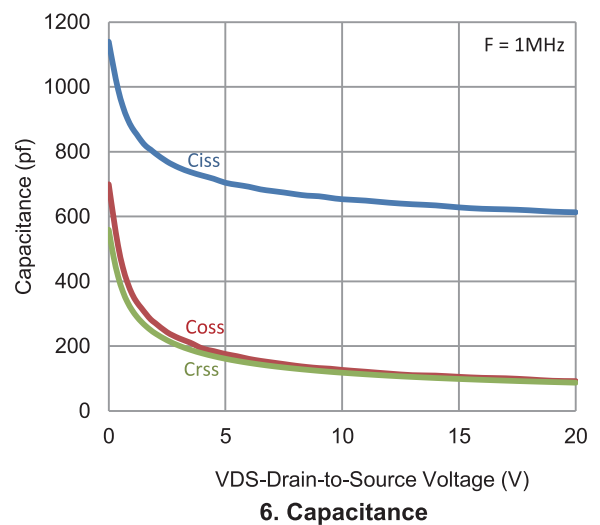
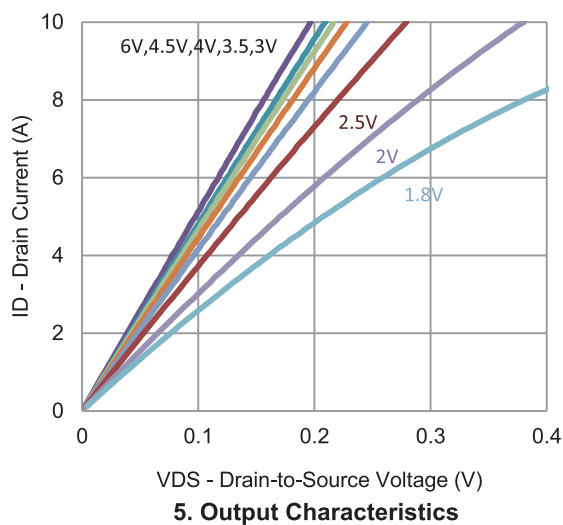
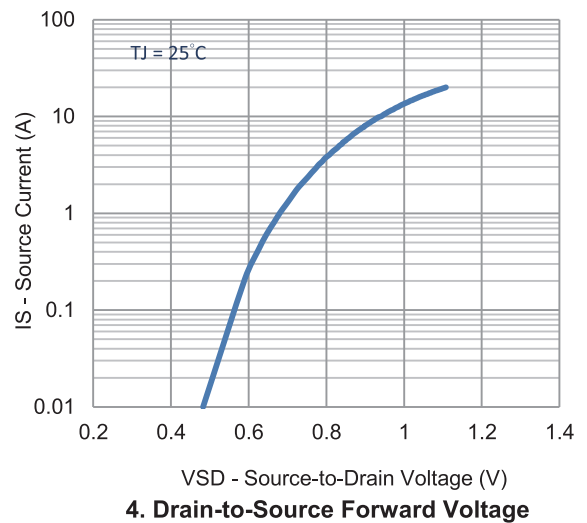
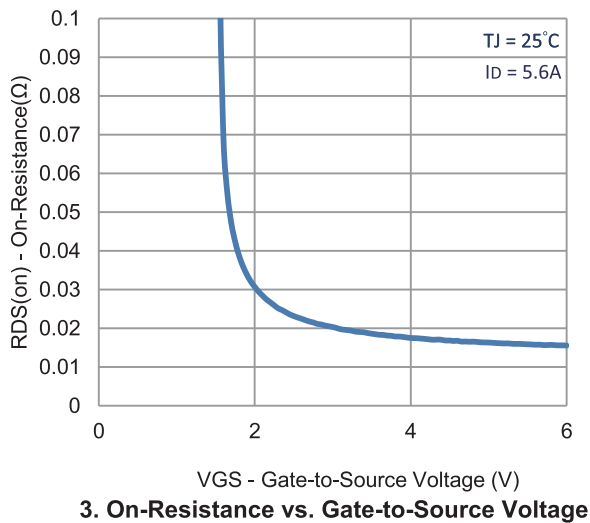
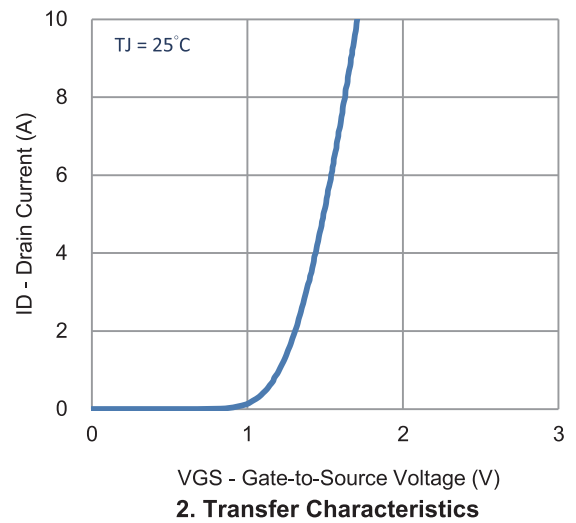
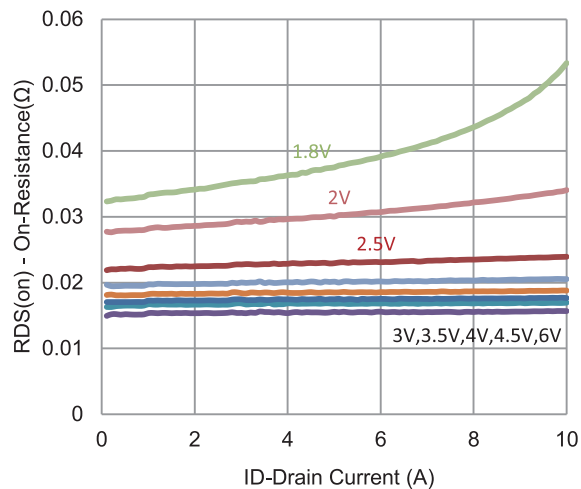
Electrical Characteristics

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static						
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 10	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 16 V, V_{GS} = 0 V$			1	μA
		$V_{DS} = 16 V, V_{GS} = 0 V, T_J = 55^\circ C$			25	
On-State Drain Current	$I_{D(on)}$	$V_{DS} = 5 V, V_{GS} = 10 V$	10			A
Drain-Source On-Resistance	$r_{DS(on)}$	$V_{GS} = 4.5 V, I_D = 5.6 A$			18	m Ω
		$V_{GS} = 2.5 V, I_D = 4.5 A$			21	
Forward Transconductance	g_{fs}	$V_{DS} = 15 V, I_D = 5.6 A$		12		S
Diode Forward Voltage	V_{SD}	$I_S = 1 A, V_{GS} = 0 V$		0.69		V
Dynamic						
Total Gate Charge	Q_g	$V_{DS} = 10 V, V_{GS} = 4.5 V,$ $I_D = 5.6 A$		11		nC
Gate-Source Charge	Q_{gs}			1.9		
Gate-Drain Charge	Q_{gd}			3.8		
Turn-On Delay Time	$t_{d(on)}$	$V_{DS} = 10 V, R_L = 1.8 \Omega,$ $I_D = 5.6 A,$ $V_{GEN} = 4.5 V, R_{GEN} = 6 \Omega$		367		ns
Rise Time	t_r			1337		
Turn-Off Delay Time	$t_{d(off)}$			4697		
Fall Time	t_f			3037		
Input Capacitance	C_{iss}	$V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz$		628		pF
Output Capacitance	C_{oss}			105		
Reverse Transfer Capacitance	C_{rss}			99		

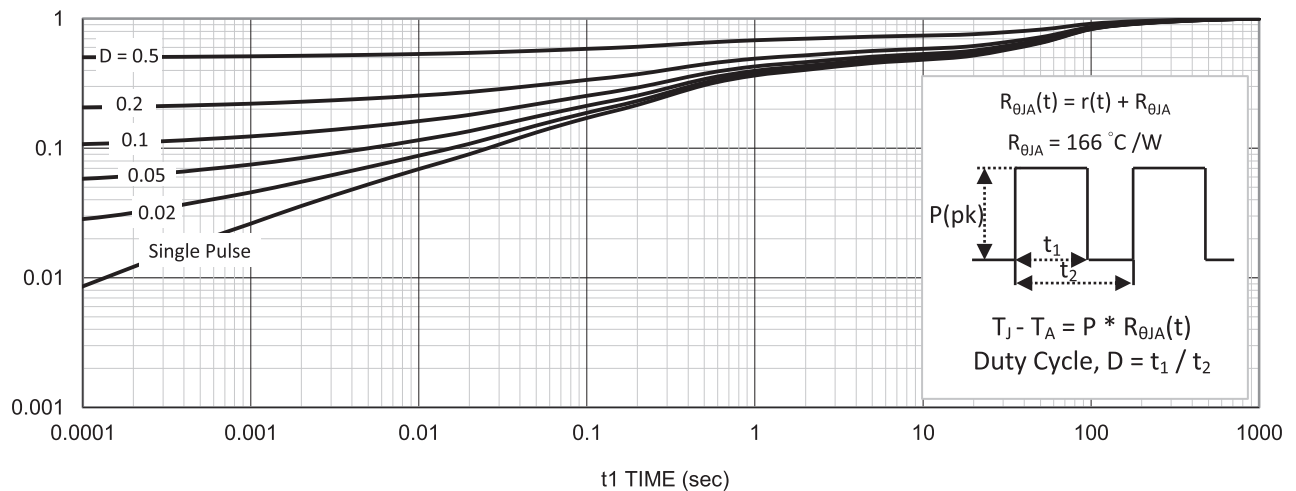
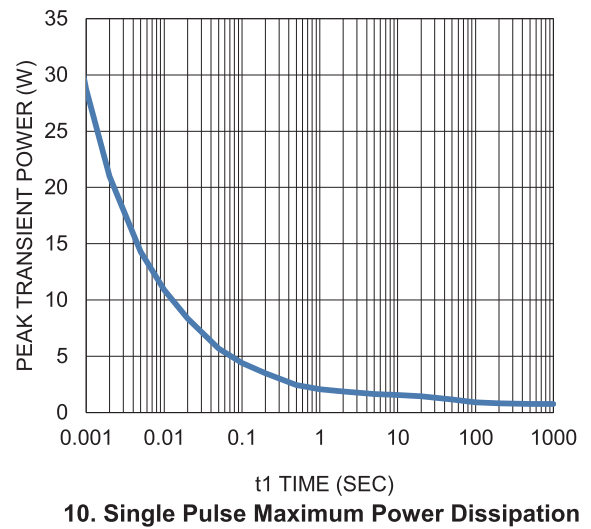
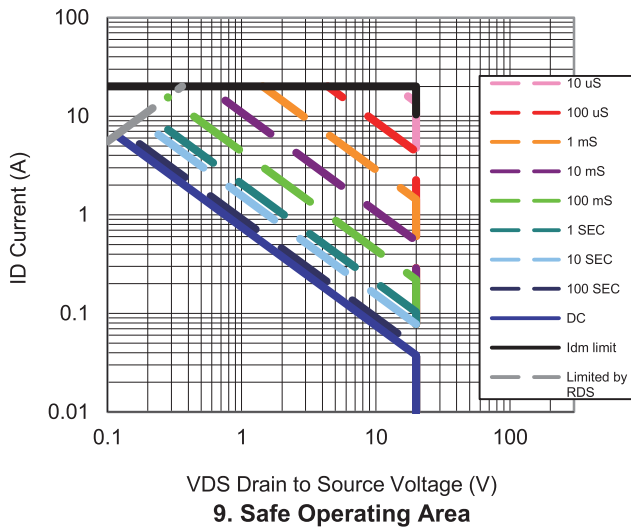
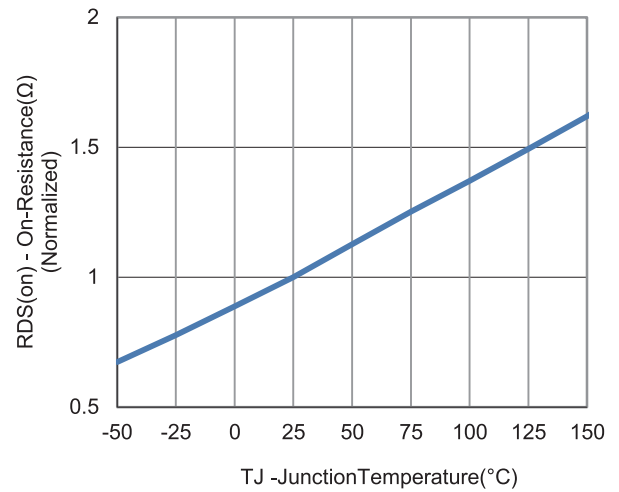
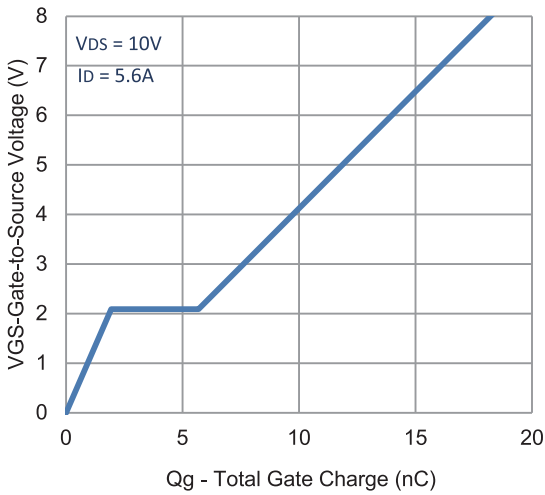
Notes

- Pulse test: PW $\leq 300 \mu s$ duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production testing.

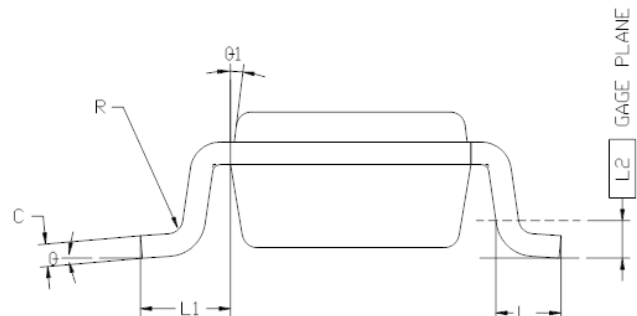
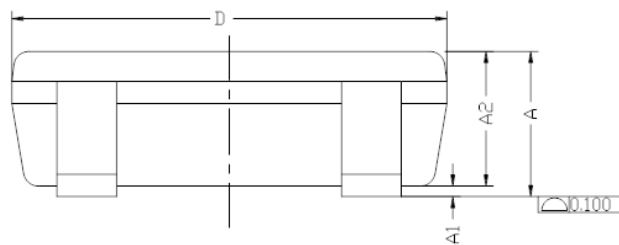
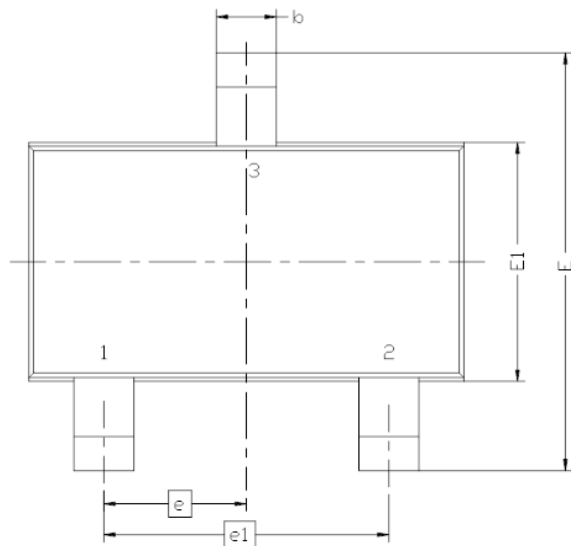
Typical Electrical Characteristics



Typical Electrical Characteristics



Package Information



DIM.	MILLIMETERS		
	MIN	NOM	MAX
A	0.80	0.95	1.10
A1	0.01	---	0.10
A2	0.85	0.90	0.925
b	0.30	0.40	0.50
c	0.10	0.15	0.25
D	2.70	2.90	3.10
E	2.60	2.80	3.00
E1	1.40	1.60	1.80
e	0.95 BSC		
e1	1.90 BSC		
L	0.30	0.40	0.60
L1	0.60REF		
L2	0.25BSC		
R	0.10	---	---
θ	0°	4°	8°
θ1	7°NOM		

Note:

1. All Dimension Are In mm.
2. Package Body Sizes Exclude Mold Flash, Protrusion Or Gate Burrs. Mold Flash, Protrusion Or Gate Burrs Shall Not Exceed 0.10 mm Per Side.
3. Package Body Sizes Determined At The Outermost Extremes Of The Plastic Body Exclusive Of Mold Flash, Tie Bar Burrs, Gate Burrs And Interlead Flash, But Including Any Mismatch Between The Top And Bottom Of The Plastic Body.
4. The Package Top May Be Smaller Than The Package Bottom.
5. Dimension "B" Does Not Include Dambar Protrusion. Allowable Dambar Protrusion Shall Be 0.08 mm Total In Excess Of "B" Dimension At Maximum Material Condition. The Dambar Cannot Be Located On The Lower Radius Of The Foot.